| ANALOG
| DEVICES

High Voltage, Low Noise, Low Distortion, Unity-Gain Stable, High Speed Op Amp

FEATURES

Ultralow noise 0.9 nV/√Hz 2.4 pA/√Hz 1.2 nV/√Hz @10 Hz Ultralow distortion: −93 dBc at 500 kHz Wide supply voltage range: ±5 V to ±16 V High speed −3 dB bandwidth: 65 MHz (G = +1) Slew rate: 55 V/μs Unity gain stable Low input offset voltage: 150 μV maximum Low input offset voltage drift: 1 μV/°C Low input bias current: −0.1 μA Low input bias current drift: 2 nA/°C Supply current: 8 mA Power-down feature

APPLICATIONS

Instrumentation Active filters DAC buffers SAR ADC drivers Optoelectronics

Rev. A

GENERAL DESCRIPTION

The ADA4898-1 is an ultralow noise and distortion, unity gain stable, voltage feedback op amp that is ideal for use in 16-bit and 18-bit systems with power supplies from \pm 5 V to \pm 16 V. The ADA4898-1 features a linear, low noise input stage and internal compensation that achieves high slew rates and low noise.

With the wide supply voltage range, low offset voltage, and wide bandwidth, the ADA4898-1 is extremely versatile, and it features a cancellation circuit that reduces input bias current.

The ADA4898-1 is available in an 8-lead, 150 mil SOIC package that features an exposed metal paddle to improve power dissipation and heat transfer to the negative supply plane. This EPAD offers a significant thermal relief over the traditional plastic packages. The ADA4898-1 is rated to work over the automotive temperature range of −40°C to +105°C.

CONNECTION DIAGRAM

ADA4898-1

Figure 2. Input Voltage Noise and Current Noise vs. Frequency

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REVISION HISTORY

$8/08$ —Rev. 0 to Rev. A

5/08-Revision 0: Initial Release

SPECIFICATIONS

±15 V SUPPLY

 $T_A = 25^{\circ}C$, $G = +1$, $R_F = 0$ Ω, R_G open, $R_L = 1$ kΩ to GND (for $G > 1$, $R_F = 100$ Ω), unless otherwise noted.

±5 V SUPPLY

 $T_A = 25^{\circ}C$, $G = +1$, $R_F = 0 \Omega$, R_G open, $R_L = 1$ k Ω to GND (for $G > 1$, $R_F = 100 \Omega$), unless otherwise noted.

Table 2.

ABSOLUTE MAXIMUM RATINGS

Table 3.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 $θ_{IA}$ is specified for the worst-case conditions, that is, $θ_{IA}$ is specified for a device soldered in the circuit board with its exposed paddle soldered to a pad on the PCB surface that is thermally connected to a copper plane, with zero airflow.

Table 4.

MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the ADA4898-1 package is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4898-1. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the output load drive. The quiescent power is the voltage between the supply pins (V_S) times the quiescent current (IS). The power dissipated due to the load drive depends upon the particular application. For each output, the power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing θ_{IA} . In addition, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduces the θ_{JA} . The exposed paddle on the underside of the package must be soldered to a pad on the PCB surface that is thermally connected to a copper plane to achieve the specified θ_{JA} .

[Figure 3](#page-4-1) shows the maximum power dissipation in the package vs. the ambient temperature for the 8-lead SOIC_N_EP (47°C/W) on a JEDEC standard 4-layer board, with its underside paddle soldered to a pad that is thermally connected to a PCB plane. θ_{IA} values are approximations.

Figure 3. Maximum Power Dissipation vs. Ambient Temperature

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 4. Pin Configuration

Table 5. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 5. Small Signal Frequency Response for Various Gains Figure 8. Large Signal Frequency Response for Various Gains

Figure 6. Small Signal Frequency Response for Various Loads Figure 9. Large Signal Frequency Response for Various Loads

Figure 7. Small Signal Frequency Response for Various Temperatures Figure 10. Large Signal Frequency Response for Various Temperatures

Figure 11. Small Signal Frequency Response for Various Supply Voltages

Figure 12. Small Signal Frequency Response for Various Capacitive Loads

Figure 13. Voltage Noise vs. Frequency

Figure 14. Large Signal Frequency Response for Various Supply Voltages

Figure 15. 0.1 dB Flatness for Various Output Voltages

Figure 16. Input Current Noise vs. Frequency

Figure 22. Small Signal Transient Response for Various Capacitive Loads

Figure 19. Harmonic Distortion vs. Frequency and Loads

Figure 23. Small Signal Transient Response for Various Gains

Figure 24. Large Signal Transient Response for Various Supply Voltages, $R_L = 100 \Omega$

Figure 25. Settling Time

Figure 26. Large Signal Transient Response for Various Supply Voltages, $R_L = 1$ k Ω

Figure 28. Output Impedance vs. Frequency

Figure 29. Common-Mode Rejection Ratio (CMRR) vs. Frequency Figure 32. Power Supply Rejection Ratio (PSRR) vs. Frequency

Figure 31. Input Offset Voltage Distribution, $V_s = \pm 15 V$ Figure 34. Input Offset Voltage Distribution, $V_s = \pm 5 V$

TEST CIRCUITS

Figure 35. Typical Noninverting Load Configuration

Figure 36. Positive Power Supply Rejection

Figure 37. Common-Mode Rejection

Figure 38. Typical Capacitive Load Configuration

Figure 39. Negative Power Supply Rejection

THEORY OF OPERATION

The ADA4898-1 is a voltage feedback op amp that combines unity gain stability with 0.9 nV/ \sqrt{Hz} input noise. It employs a highly linear input stage that can maintain greater than −90 dBc (at 2 V p-p) distortion out to 500 kHz while in a unity-gain configuration. This rare combination of low gain stability, low input-referred noise, and extremely low distortion is the result of Analog Devices, Inc., proprietary op amp architecture and high voltage bipolar processing technology.

The simplified ADA4898-1 topology, shown in [Figure 40](#page-12-1), is a single gain stage with a unity gain output buffer. It has over 100 dB of open-loop gain and maintains precision specifications, such as CMRR, PSRR, and offset, to levels that are normally associated with topologies having two or more gain stages.

PD (POWER DOWN) PIN

The \overline{PD} pin saves power by decreasing the quiescent power dissipated in the device. It is very useful when power is an issue and the device does not need to be turned on at all times. The response of the device is rapid when going from power-down mode to full power operation mode. Note that \overline{PD} does not put the output in a high-Z state, which means that the ADA4898-1 is not recommended for use as a multiplexer.

CURRENT NOISE MEASUREMENT

To measure the very low (2.4 pA/ \sqrt{Hz}) input current noise of the ADA4898-1, 10 kΩ resistors were used on both inputs of the amplifier. [Figure 41](#page-12-2) shows the noise measurement circuit used. The 10 k Ω resistors are used on both inputs to balance the input impedance and cancel the common-mode noise. In addition, a high gain configuration is used to increase the total output noise and bring it above the noise floor of the instrument.

Figure 41. Current Noise Measurement Circuit

The current noise density (I_n) is calculated by

$$
I_n = \frac{\left[e_{no}^2 - (11 \times 18.4 \text{ nV}/\sqrt{\text{Hz}})^2\right]^{1/2} \times \sqrt{2}}{20 \text{ k}\Omega \times 11}
$$

0.1 Hz TO 10 Hz NOISE

[Figure 42](#page-13-1) shows the 0.1 Hz to 10 Hz voltage and current noise of the ADA4898-1. The peak-to-peak noise voltage is below 0.5 μV. [Figure 43](#page-13-2) shows the circuit used to measure the low frequency noise. It uses a band-pass filter of approximately 0.1 Hz and 10 Hz and a high gain stage feeding into an instrumentation amplifier.

APPLICATIONS INFORMATION **HIGHER FEEDBACK GAIN OPERATION**

The ADA4898-1 schematic for the noninverting gain configuration is nearly a textbook example (see [Figure 44](#page-14-1)). The only exception is the feedback capacitor in parallel with the feedback resistor, R_F , but this capacitor is recommended only when using a large R_F value (>300 Ω). [Figure 45](#page-14-2) shows the difference between using a 100 Ω resistor and a 1 kΩ resistor. Due to the high input capacitance in the ADA4898-1 when using a higher feedback resistor, more peaking appears in the closedloop gain. Using the lower feedback resistor resolves this issue; however, when running at higher supplies $(\pm 15 \text{ V})$ with an RF of 100 Ω, the system draws a lot of extra current into the feedback network. To avoid this problem, a higher feedback resistor can be used with a feedback capacitor in parallel. [Figure 45](#page-14-2) shows the effect of placing a feedback capacitor in parallel with a larger RF. In this gain-of-2 configuration, $R_F = R_G = 1$ k Ω and $C_F = 2.7$ pF. When using C_F , the peaking drops from 6 dB to less than 2 dB.

Figure 44. Noninverting Gain Schematic

RECOMMENDED VALUES FOR VARIOUS GAINS

[Table 6](#page-14-3) provides a useful reference for determining various gains and associated performance. R_F is set to 100 Ω for gains greater than 1. A low feedback R_F resistor value reduces peaking and minimizes the contribution to the overall noise performance of the amplifier.

+5 | 100 | 24.9 | 9 | 45 | 4.5 | 24.9 | 9 | 45 | 4.5 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 | 2.07 |

Table 6. Various Gains and Recommended Resistor Values Associated With It (Conditions: Vs = ±5 V, T $_{\rm A}$ = 25°C, R $_{\rm L}$ = 1 kΩ, R $_{\rm T}$ = 49.9 $\Omega)$

NOISE

To analyze the noise performance of an amplifier circuit, identify the noise sources, and then determine if each source has a significant contribution to the overall noise performance of the amplifier. To simplify the noise calculations, noise spectral densities were used rather than actual voltages to leave bandwidth out of the expressions (noise spectral density, which is generally expressed in nV/ \sqrt{Hz} , is equivalent to the noise in a 1 Hz bandwidth).

The noise model shown in [Figure 46](#page-15-1) has six individual noise sources: the Johnson noise of the three resistors, the op amp voltage noise, and the current noise in each input of the amplifier. Each noise source has its own contribution to the noise at the output. Noise is generally specified referred to input (RTI), but it is often simpler to calculate the noise referred to the output (RTO) and then divide by the noise gain to obtain the RTI noise.

All resistors have a Johnson noise that is calculated by

 $\sqrt{(4kBTR)}$

where:

k is Boltzmann's Constant (1.38 \times 10^{−23} J/K). *B* is the bandwidth in Hertz. *T* is the absolute temperature in Kelvin.

R is the resistance in ohms.

A simple relationship that is easy to remember is that a 50 Ω resistor generates a Johnson noise of 1 nV/√Hz at 25°C.

In applications where noise sensitivity is critical, care must be taken not to introduce other significant noise sources to the amplifier. Each resistor is a noise source. Attention to the following areas is critical to maintain low noise performance: design, layout, and component selection. A summary of noise performance for the amplifier and associated resistors is shown in [Table 6](#page-14-3).

CIRCUIT CONSIDERATIONS

Careful and deliberate attention to detail when laying out the ADA4898-1 board yields optimal performance. Power supply bypassing, parasitic capacitance, and component selection all contribute to the overall performance of the amplifier.

PCB LAYOUT

Because the ADA4898-1 can operate up to 65 MHz, it is essential that RF board layout techniques be employed. All ground and power planes under the pins of the ADA4898-1 should be cleared of copper to prevent the formation of parasitic capacitance between the input pins to ground and the output pins to ground. A single mounting pad on a SOIC footprint can add as much as 0.2 pF of capacitance to ground if the ground plane is not cleared from under the mounting pads.

POWER SUPPLY BYPASSING

Power supply bypassing for the ADA4898-1 has been optimized for frequency response and distortion performance. [Figure 44](#page-14-1) shows the recommended values and location of the bypass capacitors. Power supply bypassing is critical for stability, frequency response, distortion, and PSR performance. The 0.1 μF capacitors shown in [Figure 44](#page-14-1) should be as close to the supply pins of the ADA4898-1 as possible. The 10 μF electrolytic capacitors should be adjacent to but not necessarily close to the 0.1 μF capacitors. The capacitor between the two supplies helps improve PSR and distortion performance. In some cases, additional paralleled capacitors can help improve frequency and transient response.

GROUNDING

Ground and power planes should be used where possible. Ground and power planes reduce the resistance and inductance of the power planes and ground returns. The returns for the input and output terminations, bypass capacitors, and RG should all be kept as close to the ADA4898-1 as possible. The output load ground and the bypass capacitor grounds should be returned to the same point on the ground plane to minimize parasitic trace inductance, ringing, and overshoot and to improve distortion performance.

The ADA4898-1 package features an exposed paddle. For optimum electrical and thermal performance, solder this paddle to negative supply plane. For more information on high speed circuit design, see *A Practical Guide to High-Speed Printed-Circuit-Board Layout*, Analog Dialogue: PCB Layout at [www.analog.com.](http://www.analog.com/)

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OUTLINE DIMENSIONS

COMPLIANT TO JEDEC STANDARDS MS-012-AA CONTROLLING DIMENSIONS ARE IN MILLIMETER; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 47. 8-Lead Standard Small Outline Package with Exposed Pad [SOIC_N_EP] (RD-8-1) Dimensions shown in millimeters and (inches)

ORDERING GUIDE

 $1 Z =$ RoHS Compliant Part.

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